



## P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$V_{DS}(V)$ $R_{DS(on)}(\Omega)$		Q <sub>g</sub> (Typ.)		
- 20	0.0062 at V <sub>GS</sub> = - 4.5 V	- 26.6	59 nC		
- 20	0.0105 at V <sub>GS</sub> = - 2.5 V	- 20.6	39110		

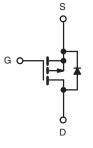
## **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



#### **APPLICATIONS**

- · Load Switch
- Adapter Switch
  - Notebook
  - Game Station



P-Channel MOSFET

	SO-8	
S 1 S 2 S 3 G 4		8 D 7 D 6 D 5 D
	Top View	

Ordering Information: Si4477DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 20	V		
Gate-Source Voltage		V <sub>GS</sub>	± 12		
	T <sub>C</sub> = 25 °C		- 26.6		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 21.3		
Continuous Diain Current (1) = 150 C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	- 18 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 14.5 <sup>a, b</sup>		
Pulsed Drain Current	I <sub>DM</sub>	- 60	Α		
Continuous Source Drain Diada Current	T <sub>C</sub> = 25 °C	I.	- 5.5		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	ls —	- 2.5 <sup>a, b</sup>		
Avalanche Current		I <sub>AS</sub>	30		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		6.6		
Mariana Davia Dissination	T <sub>C</sub> = 70 °C		4.2	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 <sup>a, b</sup>	vv	
	T <sub>A</sub> = 70 °C		1.95 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	34	41	°C/W	
Maximum Junction-to-Foot	Steady State	$R_{thJF}$	15	19	C/VV	

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 80 °C/W.
- d. Based on  $T_C$  = 25 °C.



<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 13		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	,		4.1			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 0.6		- 1.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	lace	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 1	μΑ	
Zeio Gate Voltage Diain Current	I <sub>DSS</sub>				- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 30			Α	
Durin Oranga Or Olata Basistana A	D	$V_{GS} = -4.5 \text{ V}, I_D = -18 \text{ A}$		0.0051	0.0062	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 14 A		0.0085	0.0105		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 3.5 A		10		S	
Dynamic <sup>b</sup>	•						
Input Capacitance	C <sub>iss</sub>			4600		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		980			
Reverse Transfer Capacitance	C <sub>rss</sub>	]		175			
Total Cata Charge	Qg	$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -18 \text{ A}$		125	190	nC	
Total Gate Charge				59	90		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -18 \text{ A}$		10			
Gate-Drain Charge	$Q_{gd}$	]		19			
Gate Resistance	$R_{g}$	f = 1 MHz		1.3	2.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			13	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 10 $\Omega$		10	20	1	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 1 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		100	150		
Fall Time	t <sub>f</sub>	]		25	40		
Turn-On Delay Time	t <sub>d(on)</sub>			42	60	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 10 $\Omega$		42	60		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 1 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		100	150		
Fall Time	t <sub>f</sub>	]		42	60		
<b>Drain-Source Body Diode Characteris</b>	tics						
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 5.5	^	
Pulse Diode Forward Current	I <sub>SM</sub>	_			- 60	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 5 A, V <sub>GS</sub> = 0 V		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- 55		42	60	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1 054 31/31 4004/ 7 5500		40	60	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -3.5 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		20		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			22			

#### Notes:

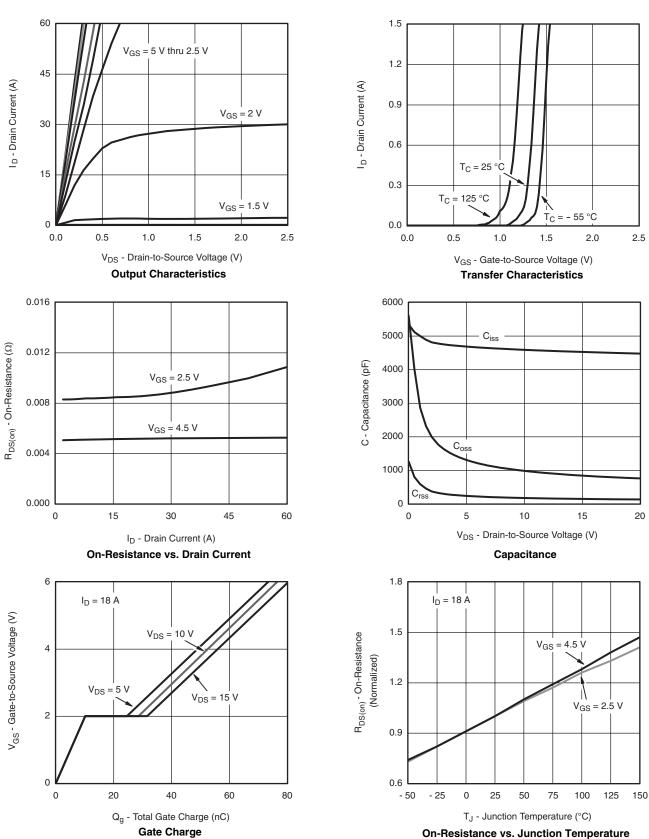
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



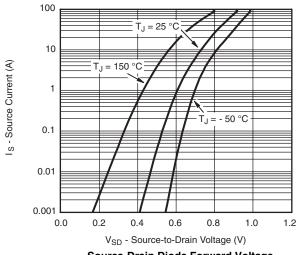


## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

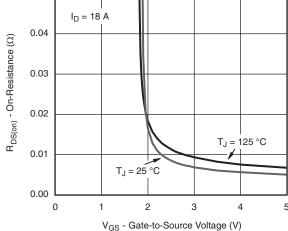


# VISHAY

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



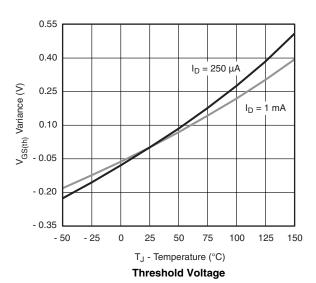
#### Source-Drain Diode Forward Voltage

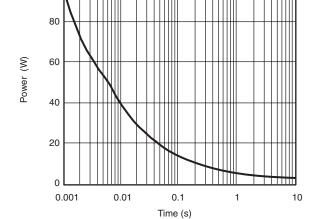


0.05

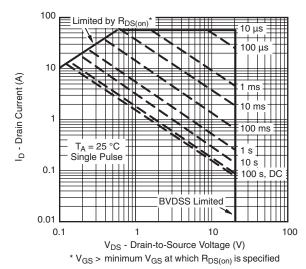
100

On-Resistance vs. Gate-to-Source Voltage



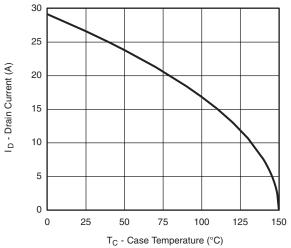


Single Pulse Power, Junction-to-Ambient

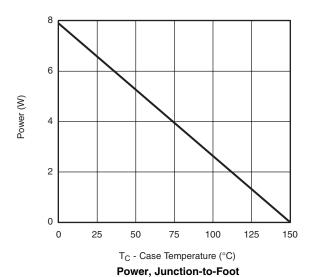


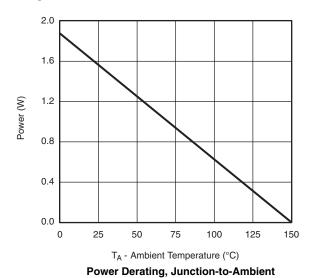
Safe Operating Area

## MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### **Current Derating\***

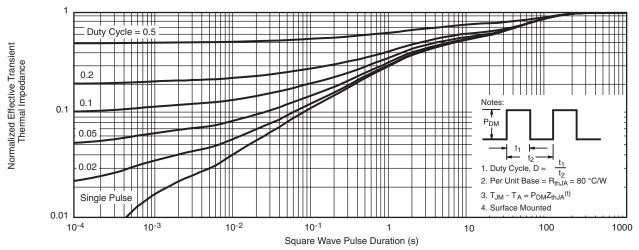




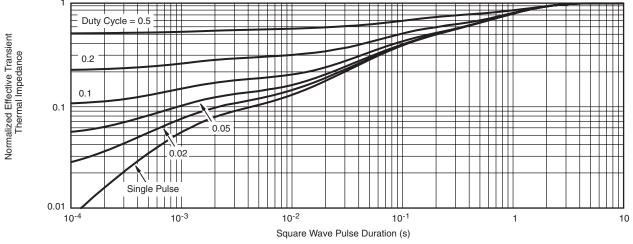
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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6



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Bev   11-Sen-06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

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#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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